



US 20190157365A1

(19) **United States**(12) **Patent Application Publication**
Taneda et al.(10) **Pub. No.: US 2019/0157365 A1**(43) **Pub. Date: May 23, 2019**(54) **DISPLAY UNIT****Publication Classification**(71) Applicant: **Sony Corporation**, Tokyo (JP)(51) **Int. Cl.****H01L 27/32** (2006.01)**G09G 3/3233** (2006.01)(72) Inventors: **Takayuki Taneda**, Aichi (JP); **Tetsuro Yamamoto**, Kanagawa (JP); **Katsuhide Uchino**, Kanagawa (JP)(52) **U.S. Cl.**CPC **H01L 27/3262** (2013.01); **H01L 27/3206** (2013.01); **H01L 27/3265** (2013.01); **H01L 27/3244** (2013.01); **G09G 2300/0809** (2013.01); **H01L 27/3211** (2013.01); **G09G 2300/0452** (2013.01); **H01L 27/3276** (2013.01); **G09G 3/3233** (2013.01)(21) Appl. No.: **16/170,726**(22) Filed: **Oct. 25, 2018****Related U.S. Application Data**

(63) Continuation of application No. 15/617,275, filed on Jun. 8, 2017, now Pat. No. 10,115,779, which is a continuation of application No. 15/172,899, filed on Jun. 3, 2016, now Pat. No. 9,711,581, which is a continuation of application No. 14/945,794, filed on Nov. 19, 2015, now Pat. No. 9,385,173, which is a continuation of application No. 14/616,941, filed on Feb. 9, 2015, now Pat. No. 9,287,331, which is a continuation of application No. 14/454,211, filed on Aug. 7, 2014, now Pat. No. 9,059,122, which is a continuation of application No. 14/197,778, filed on Mar. 5, 2014, now Pat. No. 8,841,672, which is a continuation of application No. 14/066,106, filed on Oct. 29, 2013, now Pat. No. 8,742,419, which is a continuation of application No. 12/660,846, filed on Mar. 5, 2010, now Pat. No. 8,610,122.

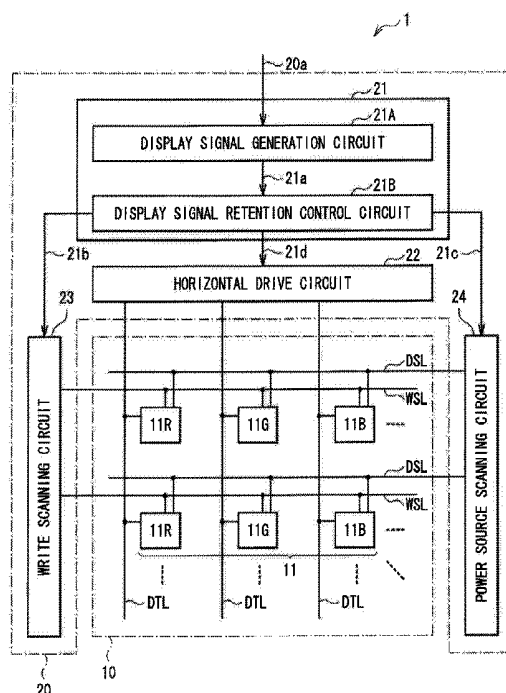
(57)

ABSTRACT

A display unit with which lowering of long-term reliability of a transistor is decreased is provided. The display unit includes a display section having a plurality of organic EL devices with light emitting color different from each other and a plurality of pixel circuits that are singly provided for every said organic EL device for every pixel. The pixel circuit has a first transistor for writing a video signal, a second transistor for driving the organic EL device based on the video signal written by the first transistor, and a retentive capacity, and out of the first transistor and the second transistor, a third transistor provided correspondingly to a second organic EL device adjacent to a first organic EL device is arranged farther from the first organic EL device than a first retentive capacity provided correspondingly to the second organic EL device out of the retentive capacity.

(30) **Foreign Application Priority Data**

Mar. 13, 2009 (JP) P2009-061713



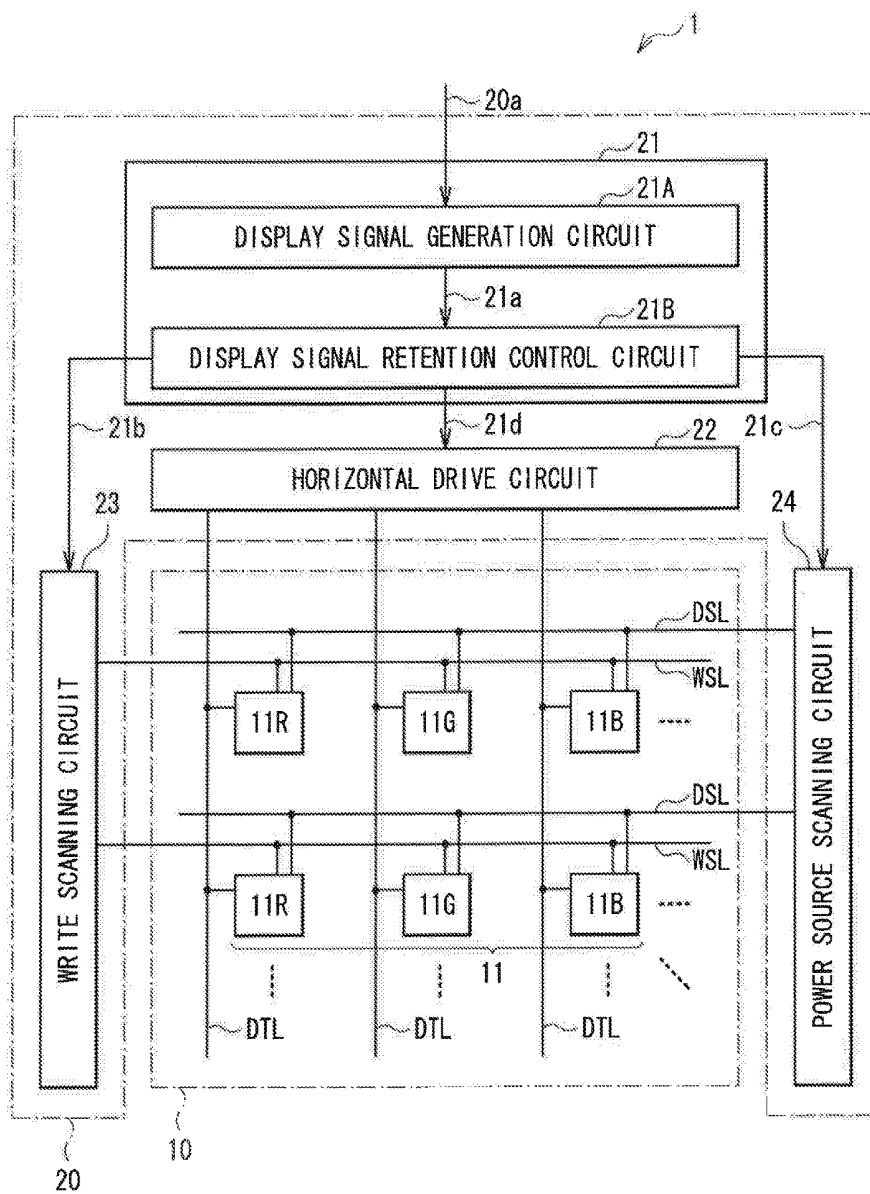


FIG. 1

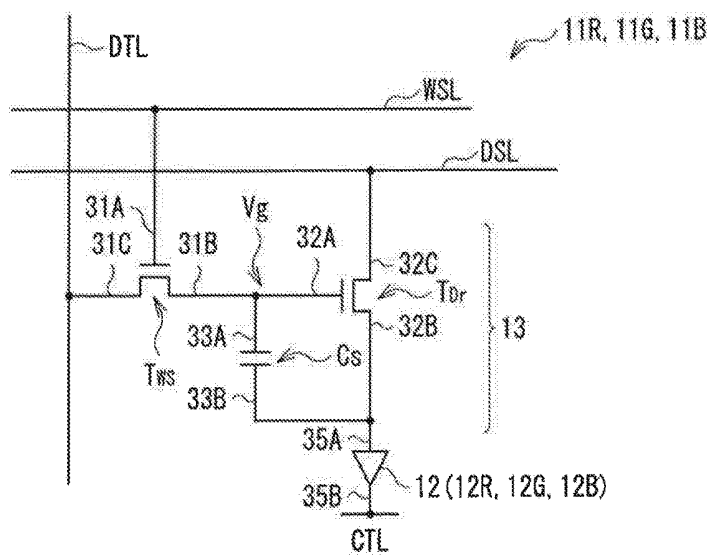


FIG. 2

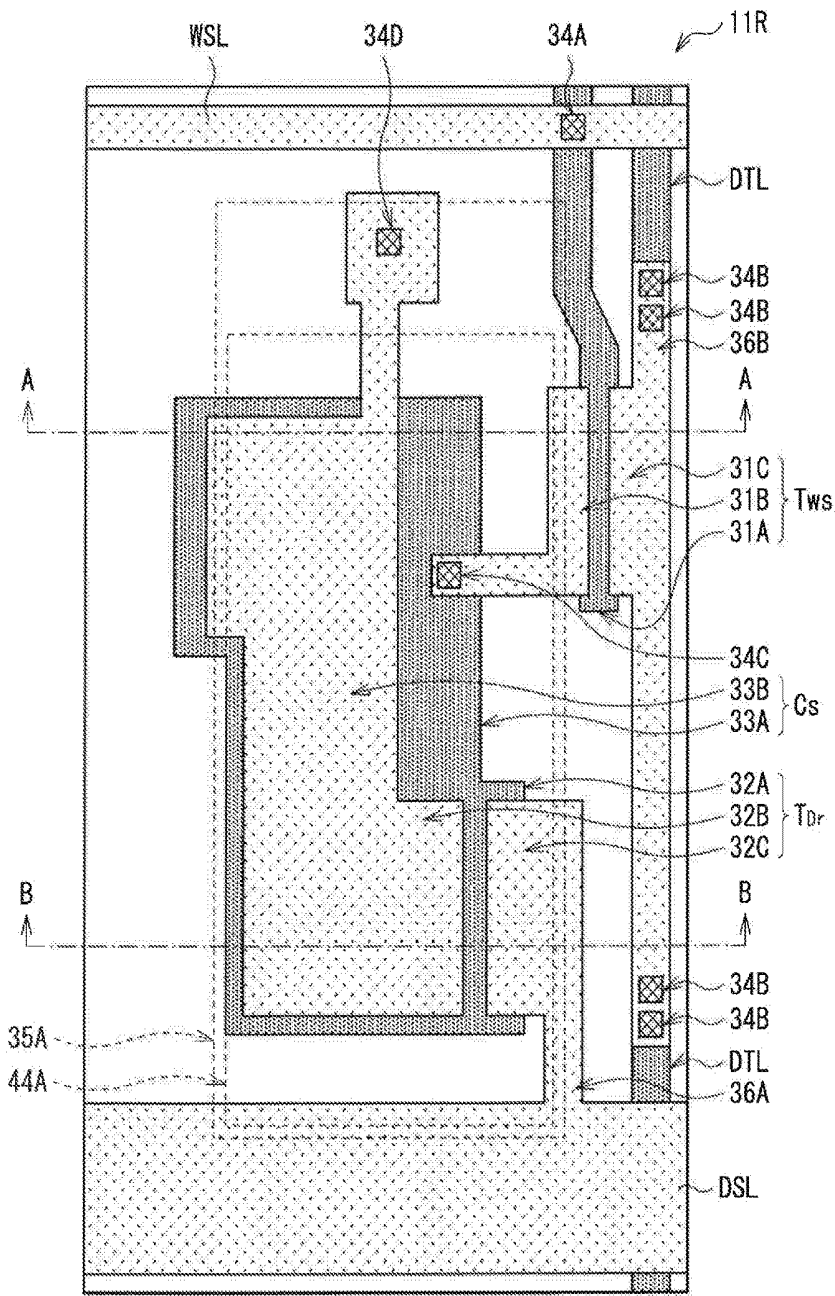


FIG. 3

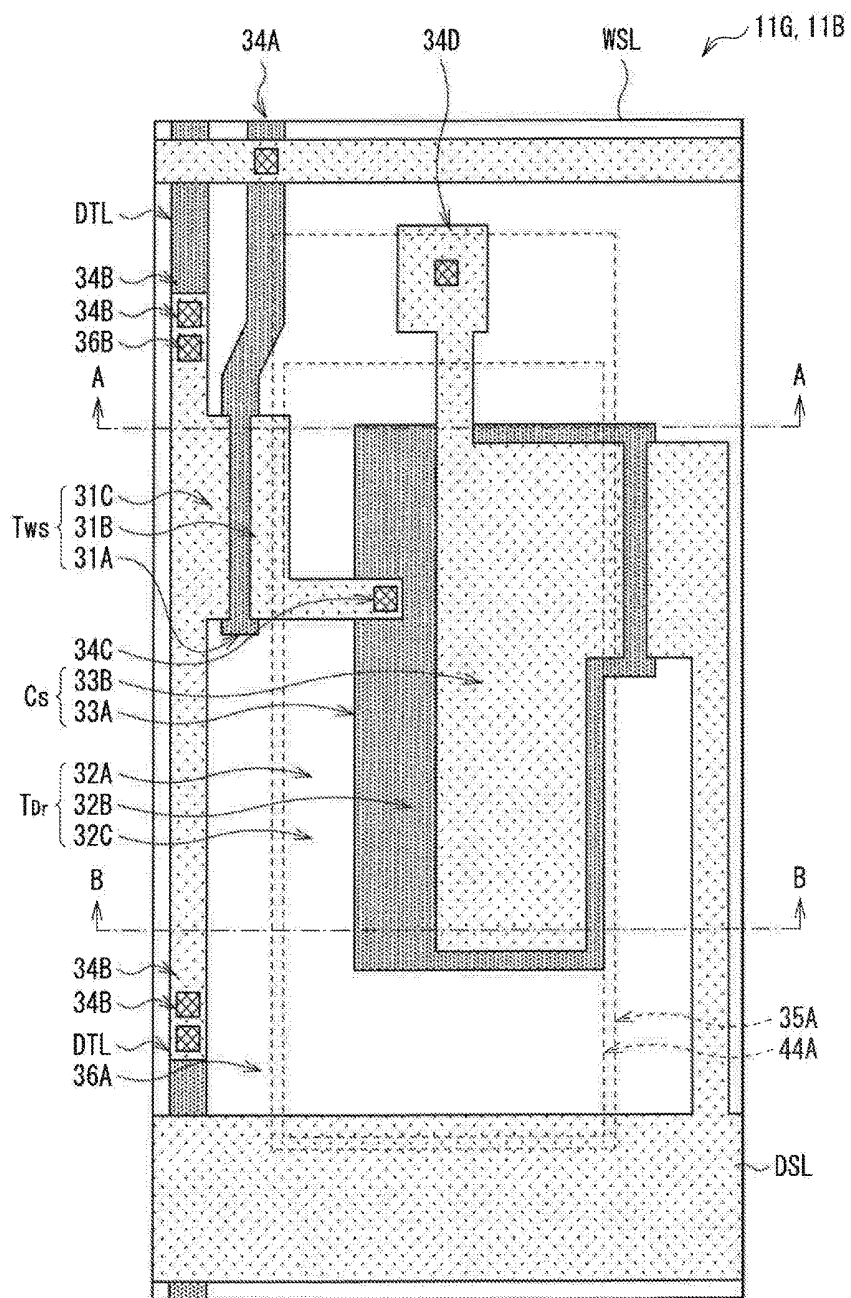


FIG. 4

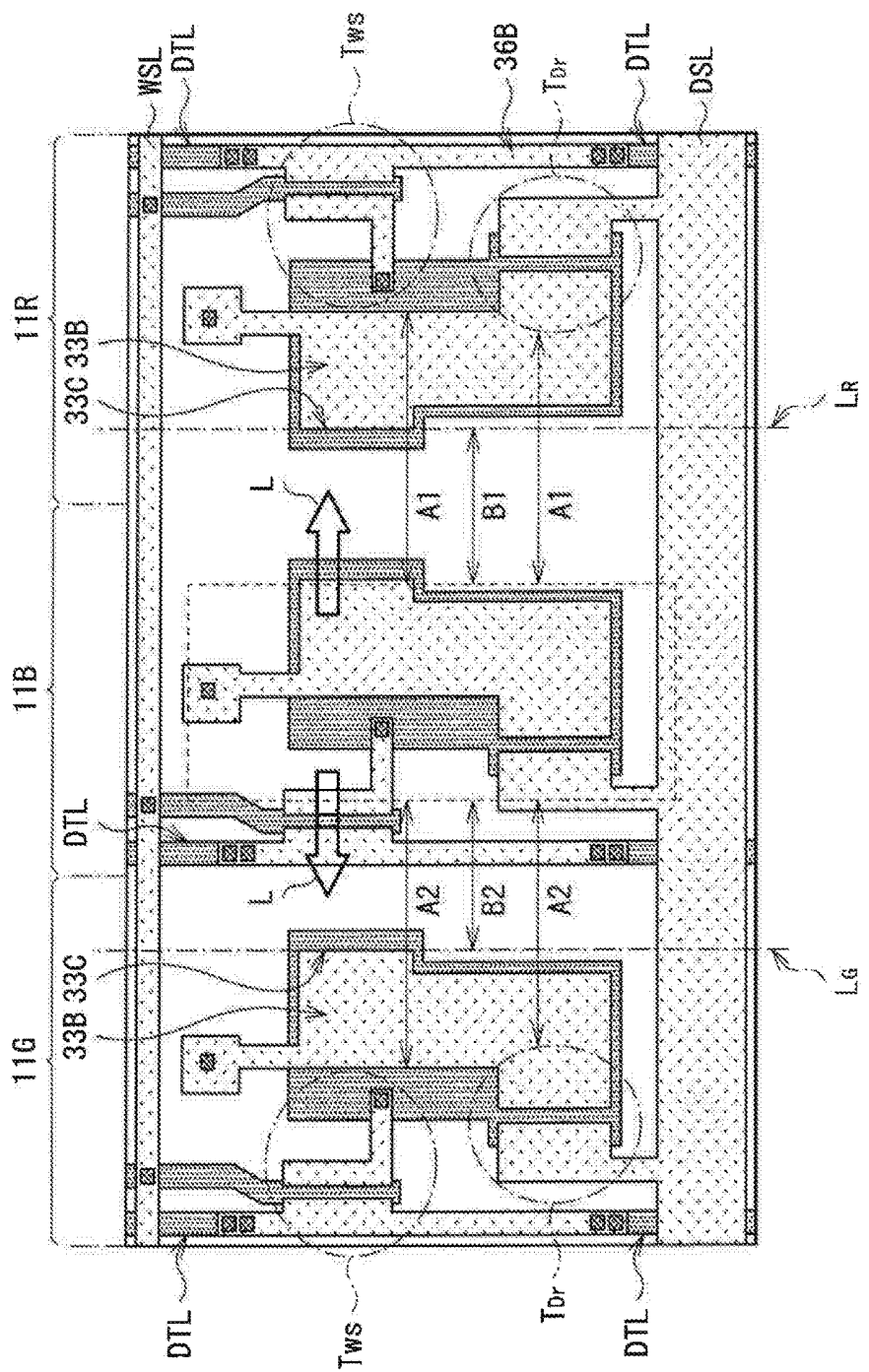


FIG. 5

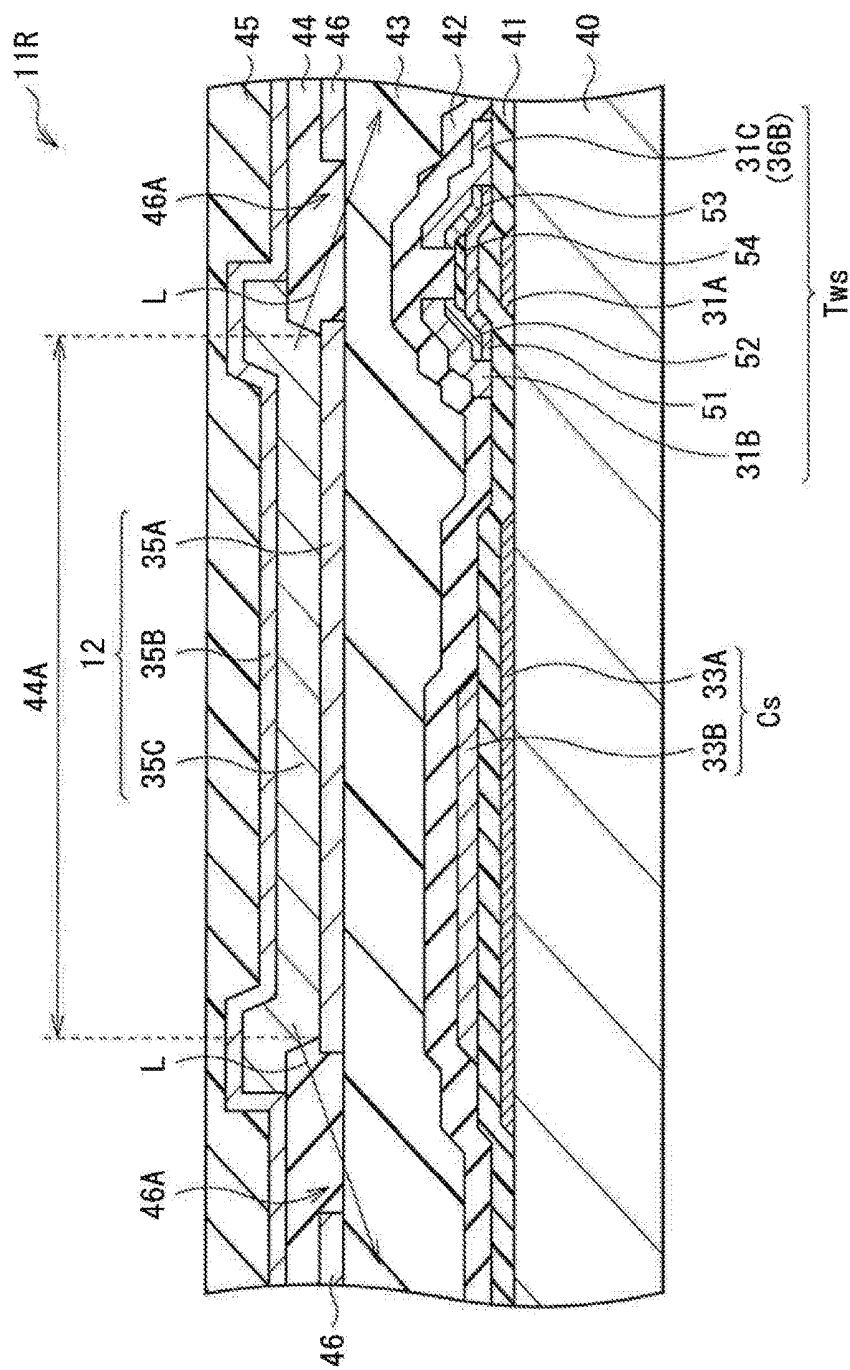
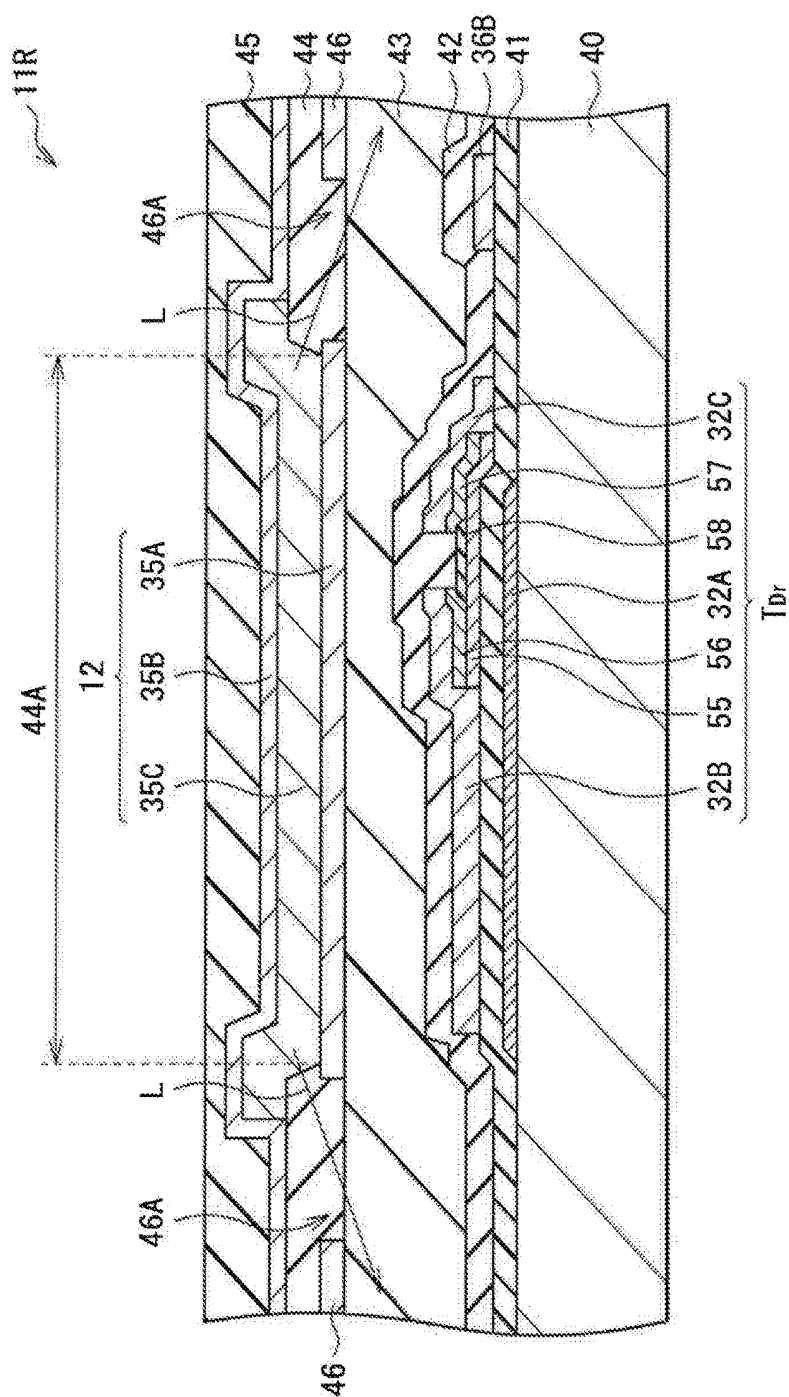


FIG. 6



7
G.
L

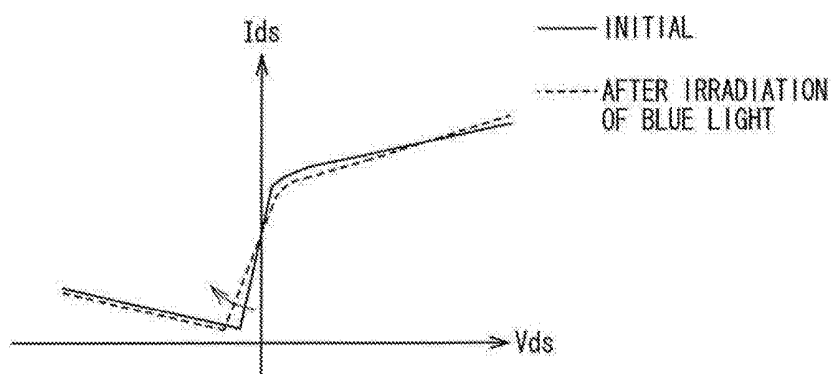


FIG. 8

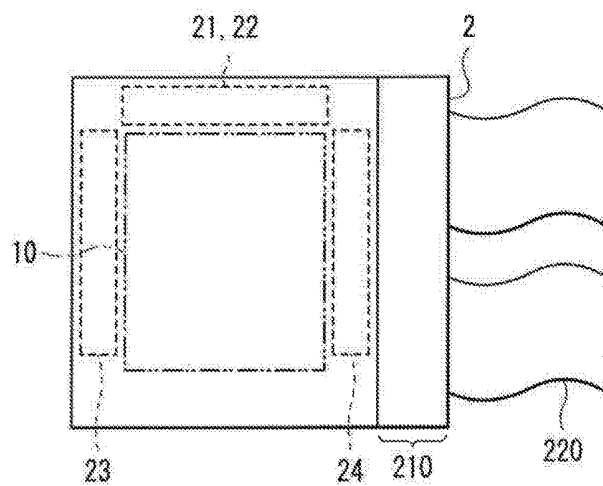


FIG. 9

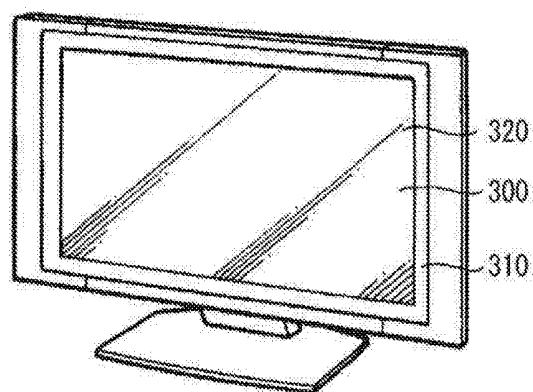
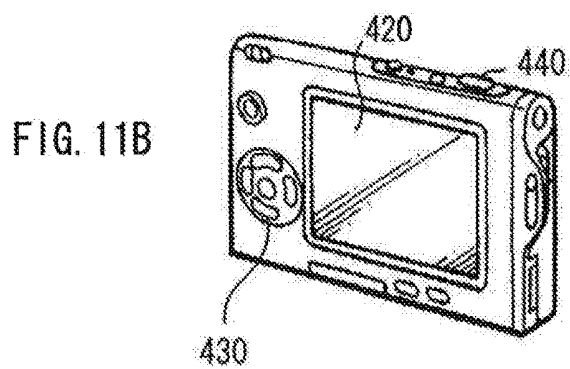
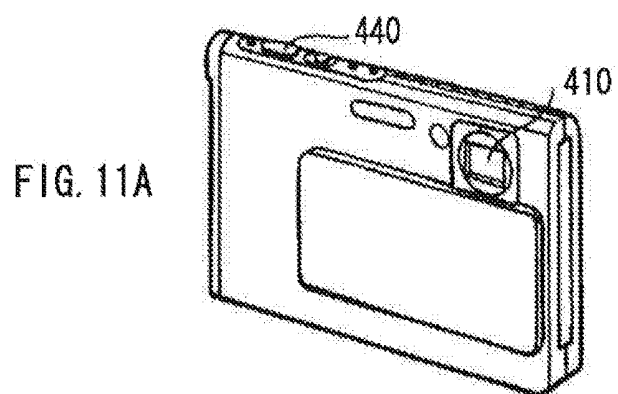


FIG. 10



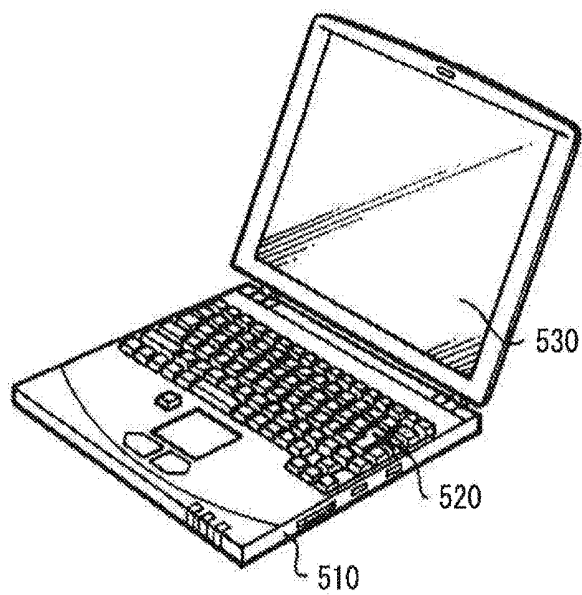


FIG. 12

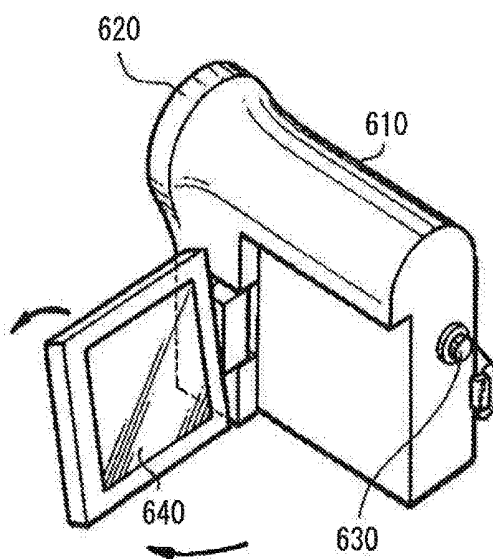


FIG. 13

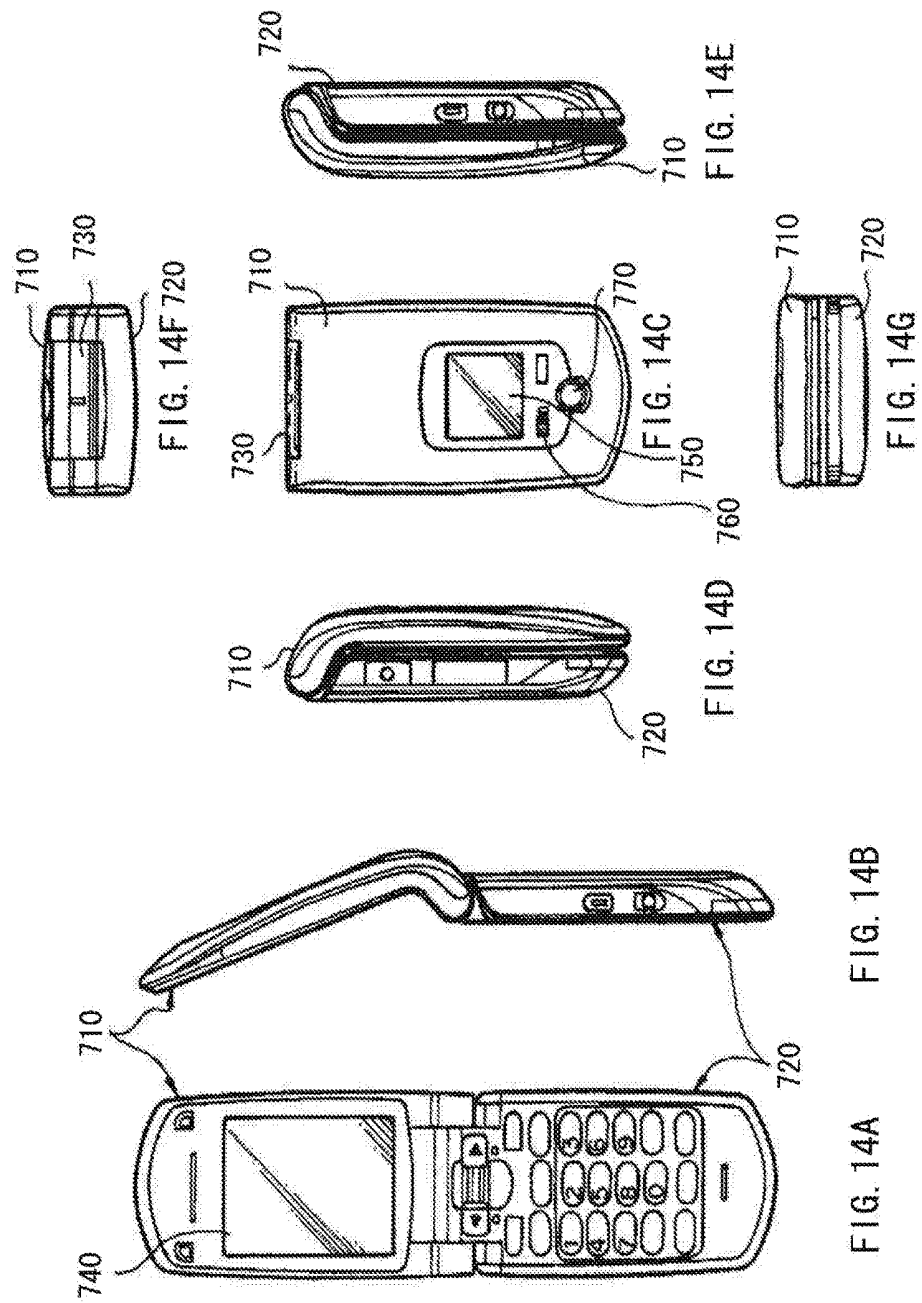


FIG. 14A

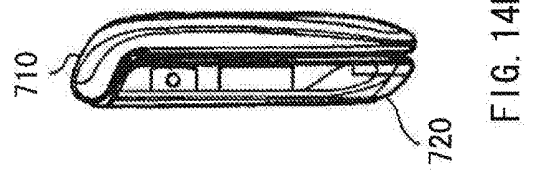


FIG. 14D

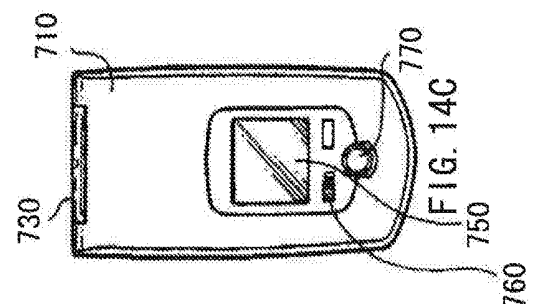


FIG. 14C

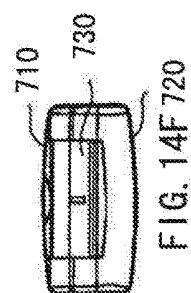


FIG. 14F

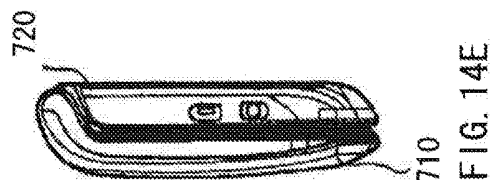


FIG. 14E

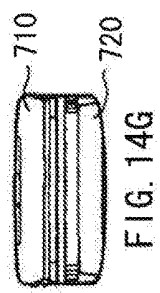


FIG. 14G

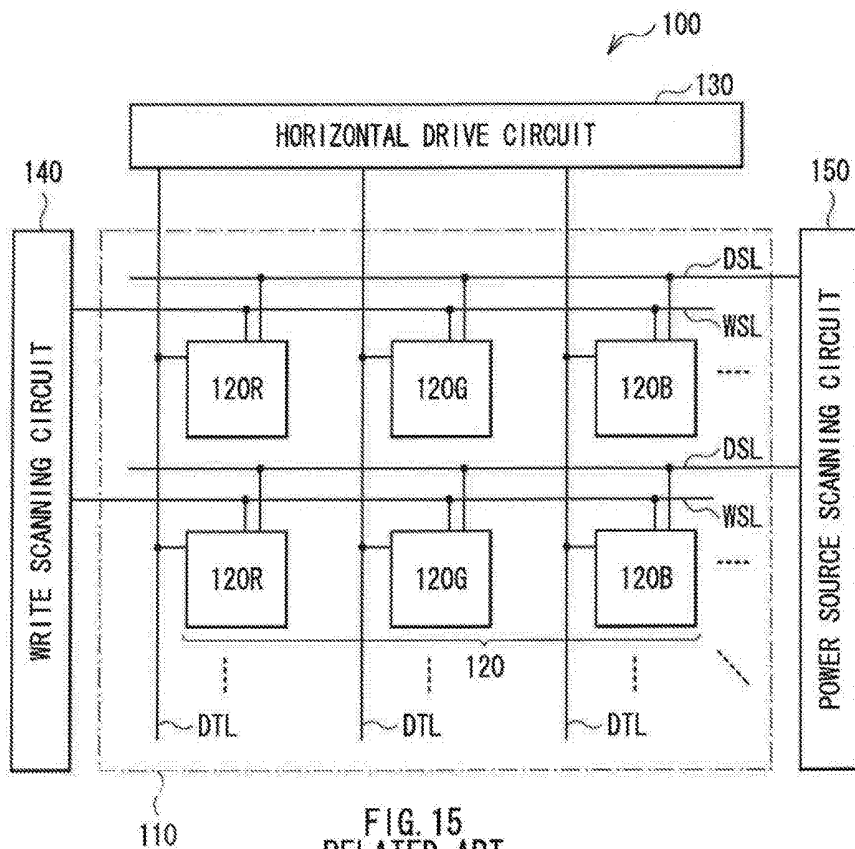


FIG. 15
RELATED ART

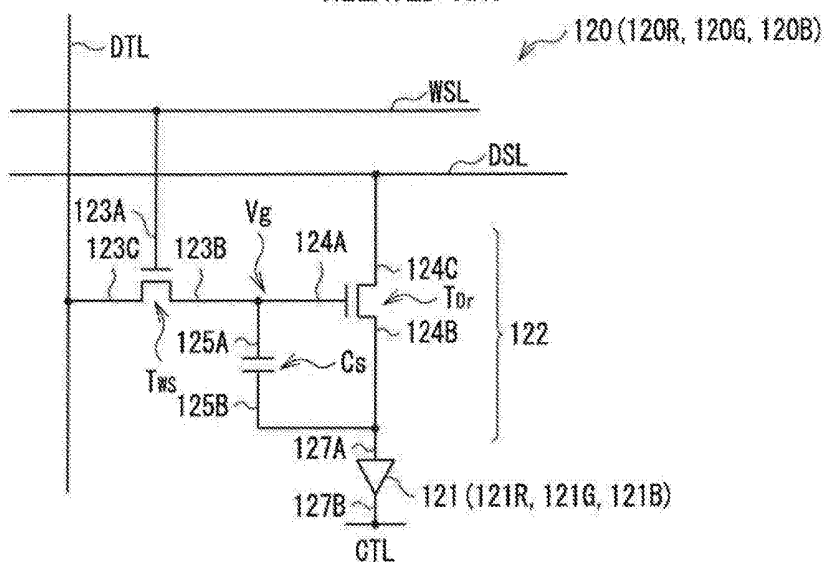
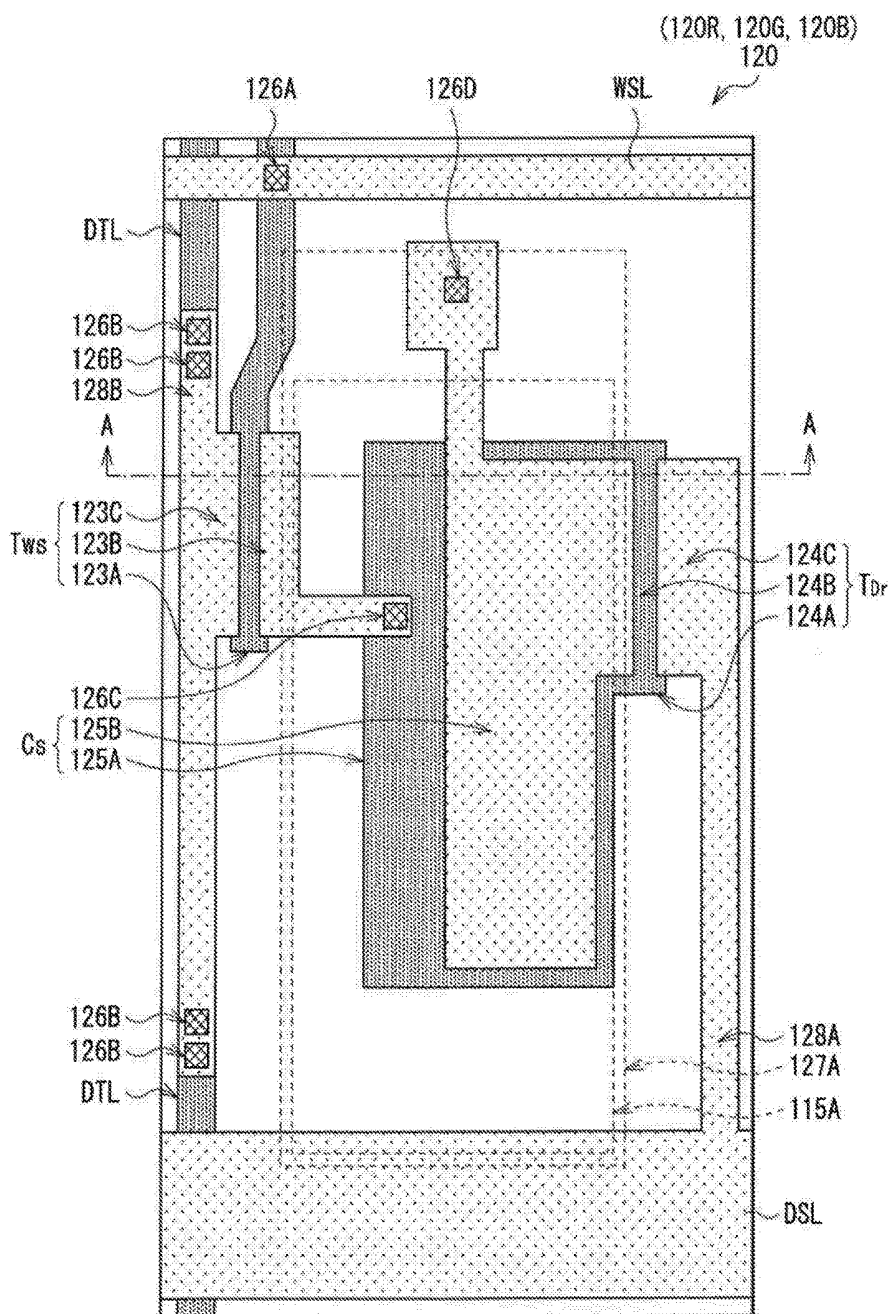


FIG. 16
PRIOR ART



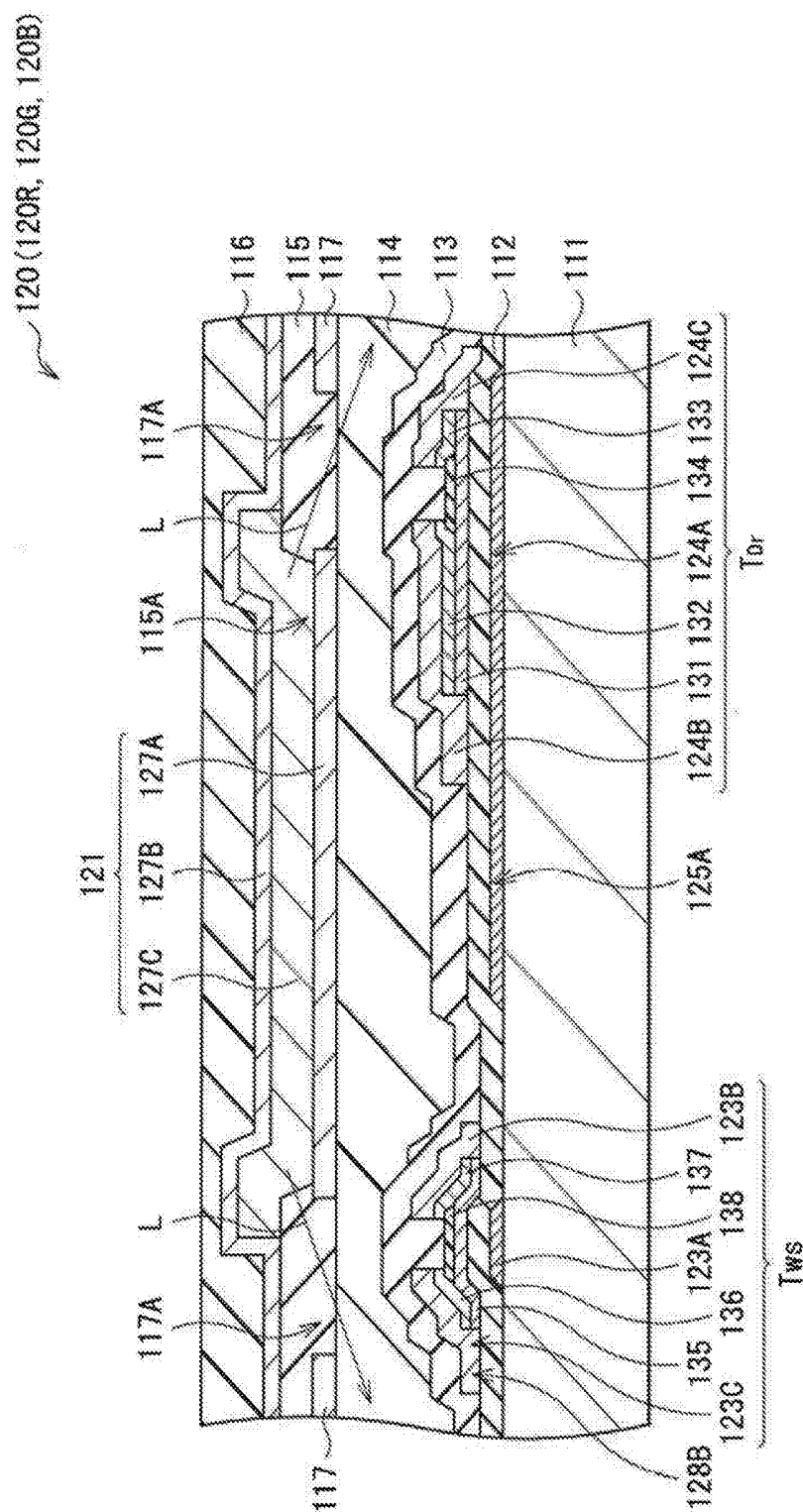


FIG. 18

PRIOR ART

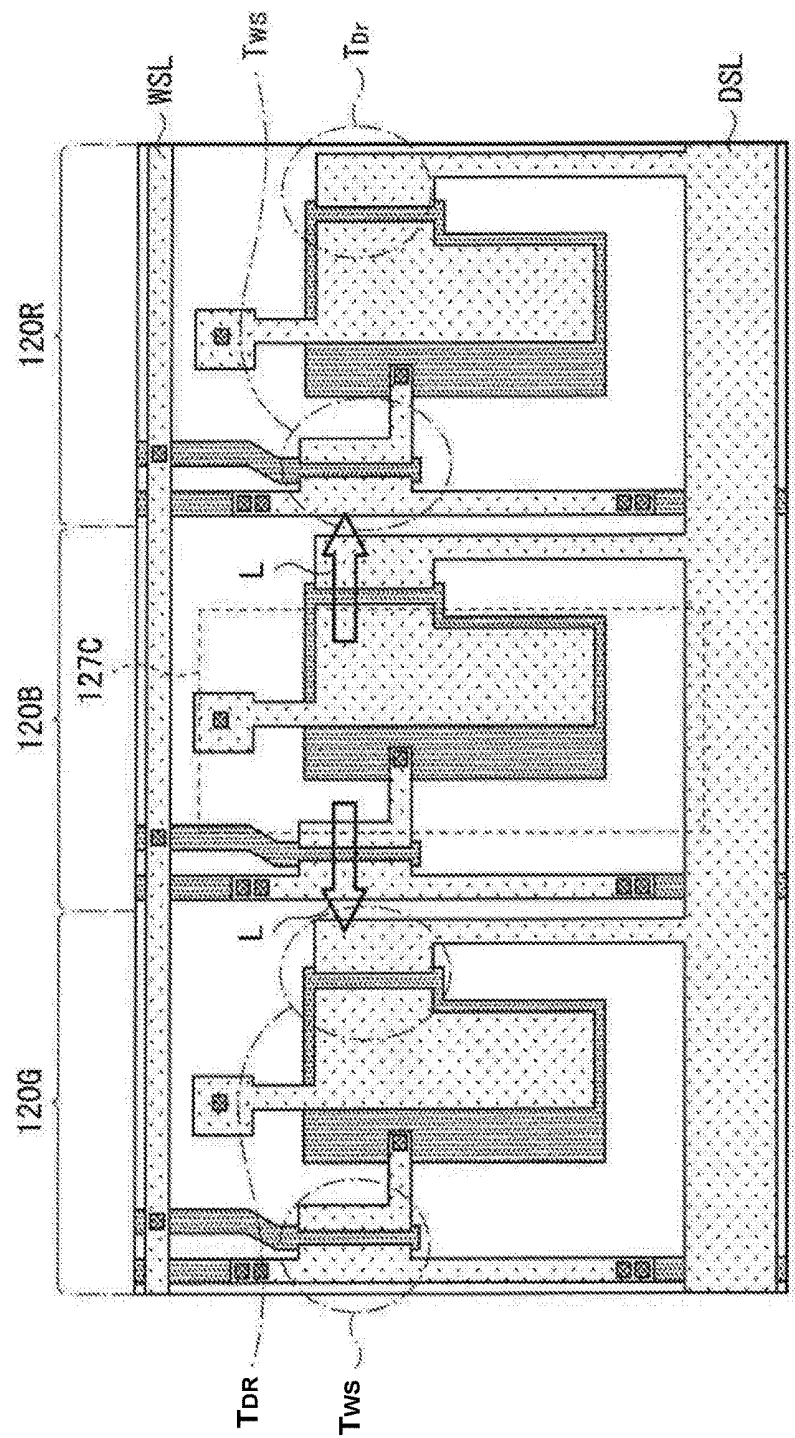


FIG. 19
PRIOR ART

DISPLAY UNIT

BACKGROUND OF THE INVENTION

1. Field of the Invention

[0001] The present invention relates to a display unit including an organic EL (electro luminescence) device.

2. Description of the Related Art

[0002] In recent years, in the field of display units for displaying images, display units including as a light emitting device of a pixel, a current drive type optical device with the light emitting luminance changeable according to the flowing current value such as an organic EL device have been developed, and such display units are facilitated to be commercialized (for example, refer to Japanese Unexamined Patent Application Publication No. 2008-083272).

[0003] The organic EL device is a self-light emitting device differently from a liquid crystal device or the like. Thus, a display unit (organic EL display unit) including the organic EL device does not need a light source (backlight). Accordingly, in the organic EL display unit, compared to a liquid crystal display unit necessary for a light source, the image visibility is high, the electric power consumption is low, and the device response rate is high.

[0004] Drive systems in the organic EL display unit include simple (passive) matrix system and active matrix system as in the liquid crystal display unit. The former system has a disadvantage that it is difficult to realize a large and high definition display unit, though its structure is simple. Thus, currently, the active matrix system has been actively developed. In such a system, a current flowing through a light emitting device arranged for every pixel is controlled by an active device provided in a drive circuit provided for every light emitting device (in general, TFT (Thin Film Transistor)).

[0005] FIG. 15 illustrates a schematic structure of a general organic EL display unit. A display unit 100 illustrated in FIG. 15 includes a display section 110 in which a plurality of pixels 120 are arranged in a matrix state and a drive section for driving each pixel 120 (a horizontal drive circuit 130, a writing scanning circuit 140, and a power source scanning circuit 150).

[0006] Each pixel 120 is composed of a red-use pixel 120R, a green-use pixel 120G, and a blue-use pixel 120B. As illustrated in FIG. 16 and FIG. 17, the pixels 120R, 120G, and 120B are composed of an organic EL device 121 (organic EL devices 121R, 121G, and 121B) and a pixel circuit 122 connected thereto. FIG. 16 illustrates a circuit structure of the pixels 120R, 120G, and 120B. FIG. 17 illustrates a layout of the pixels 120R, 120G, and 120B.

[0007] The pixel circuit 122 is composed of a sampling-use transistor T_{ws} , a retentive capacity C_s , and a drive-use transistor T_{Dr} , and has a circuit structure of 2Tr1C. A gate line WSL drawn from the writing scanning circuit 140 is extended in the row direction, and is connected to a gate 123A of the transistor T_{ws} through a contact 126A.

[0008] A drain line DSL drawn from the power source scanning circuit 150 is also extended in the row direction, and is connected to a drain 124C of the transistor T_{Dr} through a leading wiring 128A. Further, a signal line DTL drawn from the horizontal drive circuit 130 is extended in the column direction, and is connected to a drain 123C of the

transistor T_{ws} through a contact 126B and a leading wiring 128B. A source 123B of the transistor T_{ws} is connected to a gate 124A of the drive-use transistor T_{Dr} , and an end of the retentive capacity C_s (terminal 125A) through a contact 126C. A source 124B of the transistor T_{Dr} and the other end of the retentive capacity C_s (terminal 125B) are connected to an anode 127A of the organic EL device 121 through a contact 126D. A cathode 127B of the organic EL device 121 is connected to an external cathode line CTL.

SUMMARY OF THE INVENTION

[0009] FIG. 18 illustrates an example of a cross sectional structure taken along line A-A of FIG. 17. In the section corresponding to line A-A of FIG. 17, the pixels 120R, 120G, and 120B have a gate insulating film 112, an insulating protective film 113, and an insulating planarizing film 114 over a substrate 111. Between the substrate 111 and the gate insulating film 112, a gate 124A (terminal 125A) and a gate 123A are formed.

[0010] In a position that is between the gate insulating film 112 and the insulating protective film 113 and that is directly above the gate 124A, a channel 131, sources 132 and 124B, drains 133 and 124C, and a protective film 134 are formed. The channel 131 is formed being contacted with the gate insulating film 112 directly above the gate 124A. In a position that is between the gate insulating film 112 and the insulating protective film 113 and that is directly above the gate 123A, a channel 135, drains 136 and 123C, sources 137 and 123B, and a protective film 138 are formed.

[0011] On the insulating planarizing film 114, the organic EL device 121 is formed. The organic EL device 121 has a structure in which, for example, an anode 127A, an organic layer 127C, and a cathode 127B are sequentially layered from the substrate 111 side. In the same plane as that of the anode 127A, a cathode auxiliary wiring 117 is provided with a given clearance between the anode 127A and the cathode auxiliary wiring 117. Between the anode 127A and the cathode auxiliary wiring 117, an aperture 117A exists.

[0012] The organic EL device 121 has, for example, as illustrated in FIG. 18, a structure in which, for example, the anode 127A, the organic layer 127C, and the cathode 127B are sequentially layered from the substrate 111 side. The anode 127A has a function as a reflecting layer, and the cathode 127B has a function as a semi-transmissive reflecting layer. The anode 127A and the cathode 127B compose a resonator structure that resonates light generated in a light emitting layer (not illustrated) included in the organic layer 127C. That is, the surface on the organic layer 127C side of the anode 127A and the surface on the organic layer 127C side of the cathode 127B structure a pair of reflecting mirrors. The light generated in the light emitting layer is resonated by the pair of reflecting mirrors, and is extracted from the cathode 127B side. Thereby, the light generated in the light emitting layer generates multiple interference, the resonator structure acts as a kind of a narrow band filter. Thereby, the half bandwidth of spectrum of the extracted light is decreased, and color purity is improved.

[0013] In the same plane as that of the anode 127A of the organic EL device 121, an aperture determination insulating film 115 is formed. On the organic EL device 121, an insulating protective film 116 is formed. The aperture determination insulating film 115 has an aperture (EL aperture 115A) corresponding to the anode 127A. The EL aperture 115A is formed in part of a region opposed to the upper face

of the anode 127A. The aperture determination insulating film 115 covers an outer edge (peripheral edge) of the anode 127A. That is, only part of the upper face of the anode 127A is exposed on the bottom face of the EL aperture 115A. The organic layer 127C is contacted with the section exposed on the bottom face of the EL aperture 115A out of the upper face of the anode 127A.

[0014] In the same plane as that of the anode 127A, the cathode auxiliary wiring 117 surrounding the anode 127A is formed around the anode 127A. The cathode auxiliary wiring 117 is provided to uniformize in-plane potential distribution of the cathode 127B, and is electrically connected to the cathode 127B. The cathode auxiliary wiring 117 is arranged with a given clearance between the cathode auxiliary wiring 117 and the anode 127A, and the aperture 117A exists between the cathode auxiliary wiring 117 and the anode 127A. Thus, the cathode auxiliary wiring 117 retains insulation properties to the anode 127A.

[0015] As illustrated in FIG. 18, partial light L out of light generated in the light emitting layer is not outputted from the cathode 127B side, but is leaked to an adjacent pixel. In the case where the leaked light L enters a channel 131 of the transistors T_{Dr} and T_{ws} in the adjacent pixel, it results in error operation of the pixel circuit 122 such as increased light leak current.

[0016] In particular, in the case where blue light with short wavelength enters the channel 131, TFT characteristics are changed, for example, a threshold voltage V_{th} of a gate is shifted as time advances, resulting in lowered long-term reliability of the TFT. In the case where the channel 131 contains amorphous silicon (a-Si) or microcrystalline Si (μ -Si), lowering of long-term reliability of the TFT is significant.

[0017] For example, as illustrated in FIG. 19, the pixel 120B included in one pixel 120 is arranged between the pixel 120G included in said one pixel 120 and the pixel 120R included in another pixel 120 adjacent to said one pixel 120. In this case, the blue light L leaked from the organic layer 127C of the pixel 120B enters the transistor T_{Dr} in the pixel 120G and the transistor T_{ws} in the pixel 120R, resulting in lowered long-term reliability of the transistors T_{Dr} and T_{ws} .

[0018] In view of the foregoing disadvantage, in the invention, it is desirable to provide a display unit with which lowering of long-term reliability of a transistor is able to be decreased.

[0019] According to an embodiment of the invention, there is provided a display unit including a display section having a plurality of organic EL devices with light emitting color different from each other and a plurality of pixel circuits that are singly provided for every said organic EL device for every pixel. The pixel circuit has a first transistor for writing a video signal, a second transistor for driving the organic EL device based on the video signal written by the first transistor, and a retentive capacity. Out of the first transistor and the second transistor, a third transistor provided correspondingly to a second organic EL device adjacent to a first organic EL device is arranged farther from the first organic EL device than a first retentive capacity provided correspondingly to the second organic EL device.

[0020] In the display unit according to the embodiment of the invention, the third transistor provided correspondingly to the second organic EL device adjacent to the first organic EL device is arranged farther from the first organic EL

device than the first retentive capacity provided correspondingly to the second organic EL device. Thus, compared to a case that a distance A from the third transistor to the first organic EL device is smaller than a distance B from the first retentive capacity to the organic EL device, entrance amount of light leaked from the organic layer in the first organic EL device into the third transistor is small.

[0021] According to the display unit of the embodiment of the invention, compared to the foregoing case that the distance A is smaller than the distance B, light leaked from the organic layer in the first organic EL device into the third transistor is small. Thereby, in the case where the first organic EL device has an organic layer that generates light capable of deteriorating the first transistor and the second transistor, lowering of long-term reliability of the third transistor is able to be decreased.

[0022] Other and further objects, features and advantages of the invention will appear more fully from the following description.

BRIEF DESCRIPTION OF THE DRAWINGS

[0023] FIG. 1 is a schematic view of a display unit according to an embodiment of the invention.

[0024] FIG. 2 is a circuit diagram of the pixel of FIG. 1.

[0025] FIG. 3 is a layout diagram of the red-use pixel of FIG. 1.

[0026] FIG. 4 is a layout diagram of the blue-use pixel and the green-use pixel of FIG. 1.

[0027] FIG. 5 is a layout diagram of the pixel of FIG. 1.

[0028] FIG. 6 is a cross sectional view taken along line A-A of the pixel of FIG. 3.

[0029] FIG. 7 is a cross sectional view taken along line B-B of the pixel of FIG. 3.

[0030] FIG. 8 is a characteristics diagram illustrating V-I characteristics of the pixel of FIG. 1.

[0031] FIG. 9 is a plan view illustrating a schematic structure of a module including the display unit of the foregoing embodiment.

[0032] FIG. 10 is a perspective view illustrating an appearance of a first application example of the display unit of the foregoing embodiment.

[0033] FIG. 11A is a perspective view illustrating an appearance viewed from the front side of a second application example, and FIG. 11B is a perspective view illustrating an appearance viewed from the rear side of the second application example.

[0034] FIG. 12 is a perspective view illustrating an appearance of a third application example.

[0035] FIG. 13 is a perspective view illustrating an appearance of a fourth application example.

[0036] FIG. 14A is an elevation view of a fifth application example unclosed, FIG. 14B is a side view thereof, FIG. 14C is an elevation view of the fifth application example closed, FIG. 14D is a left side view thereof, FIG. 14E is a right side view thereof, FIG. 14F is a top view thereof, and FIG. 14G is a bottom view thereof.

[0037] FIG. 15 is a schematic structural view of an existing display unit.

[0038] FIG. 16 is a circuit diagram of the pixel of FIG. 15.

[0039] FIG. 17 is a layout diagram of the pixel of FIG. 15.

[0040] FIG. 18 is a cross sectional view taken along line A-A of the pixel of FIG. 17.

[0041] FIG. 19 is a layout diagram of the pixel of FIG. 15.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENT

[0042] An embodiment of the invention will be hereinafter described in detail with reference to the drawings. The description will be given in the following order:

- [0043] 1. Schematic structure
- [0044] 2. Layout
- [0045] 3. Cross sectional structure
- [0046] 4. Operation and effect
- [0047] 5. Modified example
- [0048] 6. Module and application examples

Schematic Structure

[0049] FIG. 1 illustrates an example of a whole structure of a display unit 1 according to an embodiment of the invention. The display unit 1 includes a display section 10 and a peripheral circuit section 20 (drive section) formed on the periphery of the display section 10 on a substrate 40 (described later) made of, for example, glass, a silicon (Si) wafer, a resin or the like.

[0050] In the display section 10, a plurality of pixels 11 are arranged in a matrix state over the whole area of the display section 10. The display section 10 displays an image based on a picture signal 20a inputted from outside by active matrix drive. Each pixel 11 includes a red-use pixel 11R, a green-use pixel 11G, and a blue-use pixel 11B.

[0051] FIG. 2 illustrates an example of a circuit structure of the pixels 11R, 11G, and 11B. In the pixels 11R, 11G, and 11B, as illustrated in FIG. 2, organic EL devices 12 (12R, 12G, and 12B) and a pixel circuit 13 are provided. The organic EL device 12B of this embodiment corresponds to a specific example of “first organic EL device” of the invention. The organic EL devices 12R and 12G of this embodiment correspond to a specific example of “second organic EL device” of the invention.

[0052] The pixel circuit 13 is composed of a transistor T_{ws} , a transistor T_{Dr} , and a retentive capacity C_s connected between a gate and a source of the transistor T_{Dr} , and has a circuit structure of 2Tr1C. The transistor T_{ws} is a writing-use transistor for writing a video signal. The transistor T_{Dr} is a drive-use transistor for driving the organic EL devices 12 based on the video signal written by the transistor T_{ws} . The transistors T_{ws} and T_{Dr} are formed from, for example, an n channel MOS type thin film transistor (TFT (Thin Film Transistor)).

[0053] The transistor T_{ws} of this embodiment corresponds to a specific example of “first transistor” of the invention. The transistor T_{Dr} of this embodiment corresponds to a specific example of “second transistor” of the invention. Further, in this embodiment, the transistors T_{ws} and T_{Dr} included in the pixels 11R and 11G correspond to a specific example of “third transistor” of the invention, and are transistors provided correspondingly to the organic EL devices 12R and 12G adjacent to the organic EL device 12B. Further, in this embodiment, the retentive capacity C_s included in the pixels 11R and 11G correspond to a specific example of “first retentive capacity” of the invention, and is a retentive capacity provided correspondingly to the organic EL devices 12R and 12G.

[0054] The peripheral circuit section 20 has a timing control circuit 21, a horizontal drive circuit 22, a writing scanning circuit 23, and a power source scanning circuit 24. The timing control circuit 21 includes a display signal

generation circuit 21A and a display signal retention control circuit 21B. Further, in the peripheral circuit section 20, a gate line WSL, a drain line DSL, a signal line DTL, and a ground line GND are provided. The ground line is intended to be connected to the ground, and a ground voltage (reference voltage) is obtained when the ground line is connected to the ground.

[0055] The display signal generation circuit 21A is intended to generate a display signal 21a for performing display on the display section 10, for example, for every 1 screen (for every 1 field display) based on a video signal 20a inputted from outside.

[0056] The display signal retention control circuit 21B is intended to store and retain the display signal 21a outputted from the display signal generation circuit 21A for every 1 screen (for every 1 field display) into a field memory composed of, for example, an SRAM (Static Random Access Memory). The display signal retention control circuit 21B further plays a role to exercise control so that the horizontal drive circuit 22, the writing scanning circuit 23, and the power source scanning circuit 24 for driving each pixel 11 are operated simultaneously with each other. Specifically, the display signal retention control circuit 21B outputs a control signal 21b to the writing scanning circuit 23, outputs a control signal 21c to the power source scanning circuit 24, and outputs a control signal 21d to the display signal drive circuit 21C respectively.

[0057] The horizontal drive circuit 22 is able to output a voltage according to the control signal 21d outputted from the display signal retention control circuit 21B. Specifically, the horizontal drive circuit 22 is intended to supply a given voltage to the pixel 11 selected by the writing scanning circuit 23 through the signal line DTL connected to each pixel 11 of the display section 10.

[0058] The writing scanning circuit 23 is able to output a voltage according to the control signal 21b outputted from the display signal retention control circuit 21B. Specifically, the writing scanning circuit 23 is intended to supply a given voltage to the pixel 11 as a drive target through the gate line WSL connected to each pixel 11 of the display section 10 to control the sampling-use transistor T_{ws} .

[0059] The power source scanning circuit 24 is able to output a voltage according to the control signal 21c outputted from the display signal retention control circuit 21B. Specifically, the power source scanning circuit 24 is intended to supply a given voltage to the pixel 11 as a drive target through the drain line DSL connected to each pixel 11 of the display section 10 to control emitting and extinguishing light of the organic EL device 12R and the like.

Layout

[0060] Next, a description will be given of a connection relation and arrangement of each element with reference to FIG. 2 to FIG. 5. FIG. 3 illustrates an example of layout of the pixel 11R. FIG. 4 illustrates an example of layout of the pixels 11G and 11B. FIG. 5 illustrates an example of layout of the pixel 11. FIG. 5 illustrates the pixels 11G and 11B included in one pixel 11 and the pixel 11R included in another pixel 11 adjacent to said one pixel 11.

[0061] First, a description will be given of points common to the respective pixels 11R, 11G, and 11B. The gate line WSL drawn from the writing scanning circuit 23 is extended in the row direction, and is connected to a gate 31A of the transistor T_{ws} through a contact 34A. The drain line DSL

drawn from the power source scanning circuit **24** is also extended in the row direction, and is connected to a drain **32C** of the transistor T_{Dr} through a leading wiring **36A**. Further, the signal line DTL drawn from the horizontal drive circuit **22** is extended in the column direction, and is connected to a drain **31C** of the transistor T_{ws} through a contact **34B** and a leading wiring **36B**. A source **31B** of the transistor T_{ws} is connected to a gate **32A** of the drive-use transistor T_{Dr} , and an end of the retentive capacity C_s (terminal **33A**). A source **32B** of the transistor T_{Dr} and the other end of the retentive capacity C_s (terminal **33B**) are connected to an anode **35A** of the organic EL device **12** through a contact **34D**. A cathode **35B** of the organic EL device **12** is connected to a cathode line CTL.

[0062] Next, a description will be mainly given of points of the respective pixels **11R**, **11G**, and **11B** that are different from each other. The pixels **11R**, **11G**, and **11B** are arranged in the row direction in this order in said one pixel **11**. That is, the pixel **11G** is arranged to the right of the pixel **11R** (to the right of the pixel **11R** in the row direction), the pixel **11B** is arranged to the right of the pixel **11G**, and the pixel **11R** of another pixel **11** is arranged to the right of the pixel **11B**.

[0063] For example, as illustrated in FIG. **3** and FIG. **5**, the pixel **11R** has a layout obtained by mirror-reversing the layout of the pixel **11B**. The transistors T_{Dr} and T_{ws} in the pixel **11R** are arranged farther from the organic EL device **11B** in the adjacent pixel **11B** than the retentive capacity C_s in the pixel **11R**. That is, the transistors T_{Dr} and T_{ws} in the pixel **11R** are arranged on the side opposite to the organic EL device **11B** in the adjacent pixel **11B** with respect to a line L_R that is contacted with the end section on the pixel **11B** side out of the retentive capacity C_s in the pixel **11R** and that is extended in the column direction. As illustrated in FIG. **5**, the transistors T_{Dr} and T_{ws} in the pixel **11R** are preferably arranged on the side opposite to the organic EL device **11B** in the adjacent pixel **11B** with respect to the retentive capacity C_s in the pixel **11R**. That is, the transistors T_{Dr} and T_{ws} in the pixel **11R** are preferably arranged in a region farthest from the organic EL device **11B** in the adjacent pixel **11B** out of the pixel **11R**.

[0064] For example, as illustrated in FIG. **4** and FIG. **5**, the pixel **11G** has a layout obtained by mirror-reversing the layout of the pixel **11R**. The transistors T_{Dr} and T_{ws} in the pixel **11G** are arranged farther from the organic EL device **11B** in the adjacent pixel **11B** than the retentive capacity C_s in the pixel **11G**. That is, the transistors T_{Dr} and T_{ws} in the pixel **11G** are arranged on the side opposite to the organic EL device **11B** in the adjacent pixel **11B** with respect to a line L_G that is contacted with the end section on the pixel **11B** side out of the retentive capacity C_s in the pixel **11G** and that is extended in the column direction. The transistors T_{Dr} and T_{ws} in the pixel **11G** are preferably arranged on the side opposite to the organic EL device **11B** in the adjacent pixel **11B** with respect to the retentive capacity C_s in the pixel **11G**. That is, the transistors T_{Dr} and T_{ws} in the pixel **11G** are preferably arranged in a region farthest from the organic EL device **11B** in the adjacent pixel **11B** out of the pixel **11G**.

[0065] For example, as illustrated in FIG. **5**, the pixel **11B** has the same layout as the layout of the pixel **11G**. The transistors T_{Dr} and T_{ws} in the pixel **11B** are arranged closer to the organic EL device **11G** in the adjacent pixel **11G** than the retentive capacity C_s in the pixel **11B**. The pixel **11B** may have a layout different from the layout of the pixel **11G**.

Cross Sectional Structure

[0066] FIG. **6** illustrates a cross sectional structure taken along line A-A of FIG. **3**. FIG. **6** includes a cross section of the transistor T_{ws} . FIG. **7** illustrates a cross sectional structure taken along line B-B of FIG. **3**. FIG. **7** includes a cross section of the transistor T_{Dr} . In this embodiment, a cross sectional structure obtained by mirror-reversing the cross sectional structure of FIG. **6** corresponds to, for example, a cross sectional structure taken along line A-A of FIG. **4**, and a cross sectional structure obtained by mirror-reversing the cross sectional structure of FIG. **7** corresponds to, for example, a cross sectional structure taken along line B-B of FIG. **4**.

[0067] The pixels **11R**, **11G**, and **11B** have a gate insulating film **41**, an insulating protective film **42**, and an insulating planarizing film **43** over a substrate **40** in the section corresponding to line A-A and line B-B of FIG. **3**. The gate insulating film **41** functions as a gate insulating film of the transistors T_{ws} and T_{Dr} . The insulating protective film **42** is intended to cover and protect the transistors T_{ws} and T_{Dr} . The insulating planarizing film **43** is provided to planarize the base of the organic EL device **12**, and cover the whole surface of the insulating protective film **42**.

[0068] In the section corresponding to line A-A of FIG. **3** (section including the cross section of the transistor T_{ws}), the gate **31A** and the terminal **33A** are formed between the substrate **40** and the gate insulating film **41**. Meanwhile, in the section corresponding to line A-A of FIG. **4** (section including the cross section of the transistor T_{Dr}), the gate **32A** is generally formed between the substrate **40** and the gate insulating film **41**. The gate **31A** is formed around a region opposed to an EL aperture **44A** described later. The terminal **33A** and the gate **32A** are generally formed in a region opposed to the EL aperture **44A**. The gate insulating film **41** covers the whole surface including the substrate **40**, the gates **31A** and **32A**, and the terminal **33A**.

[0069] In a position that is between the gate insulating film **41** and the insulating protective film **42** and that is directly above the gate **31A**, a channel **51**, sources **52** and **31B**, drains **53** and **31C**, a leading wiring **36B**, and a protective film **54** are formed. The channel **51** is formed being contacted with the gate insulating film **41** directly above the gate **31A**. The source **52** is contacted with an end of the channel **51**. The source **31B** is contacted with the source **52**. The drain **53** is contacted with the other end of the channel **51**. The drain **31C** is contacted with the drain **53**. The channel **51**, the source **52**, and the drain **53** contain, for example, amorphous silicon (a-Si), microcrystalline Si (μ -Si), or low temperature polysilicon. The protective film **54** is formed between the sources **52**, **31B** and the drains **53**, **31C**, and covers a region not contacted with the source **52** and the drain **53** out of the channel **51**.

[0070] In a position that is between the gate insulating film **41** and the insulating protective film **42** and that is directly above the gate **32A**, a channel **55**, sources **56** and **32B**, drains **57** and **32C**, and a protective film **58** are formed. Further, in a position that is between the gate insulating film **41** and the insulating protective film **42** and that is to the side of the drain **32C**, a leading wiring **36B** is formed. The channel **55** is formed being contacted with the gate insulating film **41** directly above the gate **32A**. The source **56** is contacted with an end of the channel **55**. The source **32B** is contacted with the source **56**. The drain **57** is contacted with the other end of the channel **55**. The drain **32C** is contacted

with the drain 57. The channel 55, the source 56, and the drain 57 contain, for example, amorphous silicon (a-Si), microcrystalline Si (μ -Si), or low temperature polysilicon. The protective film 58 is formed between the sources 56, 32B and the drains 57, 32C, and covers a region not contacted with the source 56 and the drain 57 out of the channel 55.

[0071] The pixels 11R, 11G, and 11B have the organic EL device 12 on the insulating planarizing film 43. The organic EL device 12 has a structure in which, for example, an anode 35A, an organic layer 35C, and a cathode 35B are sequentially layered from the substrate 40 side. The organic layer 35C includes, for example, an electron hole injection layer for improving efficiency of electron hole injection, an electron hole transport layer for improving efficiency of electron hole transport to the light emitting layer, a light emitting layer for generating light emission by electron-hole recombination, and an electron transport layer for improving efficiency of electron transport to the light emitting layer sequentially from the anode 35A side. The organic layer 35C of the pixel 11R contains a material emitting red light. The organic layer 35C of the pixel 11G contains a material emitting green light. The organic layer 35C of the pixel 11B contains a material emitting blue light. The blue light emitted from the organic layer 35C of the pixel 11B strongly has characteristics capable of deteriorating the transistor in the pixels 11R and 11G adjacent to the pixel 11B. The red light emitted from the organic layer 35C of the pixel 11R and the green light emitted from the organic layer 35C of the pixel 11G slightly have characteristics capable of deteriorating the transistor in the pixel adjacent to the pixel 11R or the pixel 11G.

[0072] The anode 35A has a function as a reflecting layer, and the cathode 35B has a function as a semi-transmissive reflecting layer. The anode 35A and the cathode 35B compose a resonator structure that resonates light generated in the light emitting layer 35C. That is, the surface on the organic layer 35C side of the anode 35A and the surface on the organic layer 35C side of the cathode 35B structure a pair of reflecting mirrors. The light generated in the light emitting layer 35C is resonated by the pair of reflecting mirrors, and is extracted from the cathode 35B side. Thereby, the light generated in the light emitting layer 35C generates multiple interference, the resonator structure acts as a kind of a narrow band filter. Thereby, the half bandwidth of spectrum of the extracted light is decreased, and color purity is improved.

[0073] The pixels 11R, 11G, and 11B have an aperture determination insulating film 44 in the same plane as that of the anode 35A of the organic EL device 12, and has an insulating protective film 45 on the organic EL device 12.

[0074] The aperture determination insulating film 44 has an aperture (EL aperture 44A) corresponding to the anode 35A. The EL aperture 44A is formed in part of a region opposed to the upper face of the anode 35A. The aperture determination insulating film 44 covers an outer edge (peripheral edge) of the anode 35A. That is, only part of the upper face of the anode 35A is exposed on the bottom face of the EL aperture 44A. The organic layer 35C is contacted with the section exposed on the bottom face of the EL aperture 44A out of the upper face of the anode 35A.

[0075] The insulating protective film 45 covers the whole surface of the cathode 35B. The insulating protective film 45 is formed from a material transparent to light emitted in the

organic EL device 12. Thus, the insulating protective film 45 is able to pass not only the light emitted in the organic EL device 12 but also outside light in the same wavelength as that of the light emitted in the organic EL device 12.

[0076] In the same plane as that of the anode 35A, a cathode auxiliary wiring 46 surrounding the anode 35A is formed around the anode 35A. The cathode auxiliary wiring 46 is provided to uniformize in-plane potential distribution of the cathode 35B, and is electrically connected to the cathode 35B. The cathode auxiliary wiring 46 is arranged with a given clearance between the cathode auxiliary wiring 46 and the anode 35A, and an aperture 46A exists between the cathode auxiliary wiring 46 and the anode 35A. Thus, the cathode auxiliary wiring 46 retains insulation properties to the anode 35A.

Operation and Effect

[0077] In the display unit 1 of this embodiment, the pixel circuit 13 is on/off controlled in the respective pixels 11R, 11G, and 11B, and a drive current is injected to the organic EL device 12 of the respective pixels 11R, 11G, and 11B. Thereby, electron-hole recombination is generated to initiate light emission. The light is reflected in a multiple fashion between the anode 35A and the cathode 35B, is transmitted through the cathode 35B, and is extracted outside. In the result, an image is displayed in the display section 10.

[0078] In general, in the organic EL display unit, for example, as illustrated in FIGS. 6, 7, and 18, partial light L out of light generated in the organic layer 35C (127C) is not outputted from the cathode 35B (127B) side, but is leaked to the adjacent pixel. For example, as illustrated in FIG. 19, in the case where the leaked light L enters the transistors T_{Dr} and T_{ws} (in particular, the channel 131) in the adjacent pixel, it results in error operation of the pixel circuit 122 such as increased light leak current.

[0079] In particular, in the case where blue light with short wavelength enters the channel 131, TFT characteristics are changed, for example, the threshold voltage V_{th} of the gate is shifted as time advances, resulting in lowered long-term reliability of the TFT. In the case where the channel 131 contains amorphous silicon (a-Si) or microcrystalline Si (μ -Si), lowering of long-term reliability of the TFT is significant.

[0080] For example, as illustrated in FIG. 19, the pixel 120B included in one pixel 120 is arranged between the pixel 120G included in said one pixel 120 and the pixel 120R included in another pixel 120 adjacent to said one pixel 120. In this case, the blue light L leaked from the organic layer 127C of the pixel 120B enters the transistor T_{Dr} in the pixel 120G and the transistor T_{ws} in the pixel 120R, resulting in lowered long-term reliability of the transistors T_{Dr} and T_{ws} .

[0081] Meanwhile, in this embodiment, for example, as illustrated in FIG. 5, the transistors T_{Dr} and T_{ws} in the pixel 11R adjacent to the pixel 11B are arranged farther from the pixel 11B than the retentive capacity C_s in the pixel 11R. Further, the transistors T_{Dr} and T_{ws} in the pixel 11G adjacent to the pixel 11B are arranged farther from the pixel 11B than the retentive capacity C_s in the pixel 11G. Thus, a distance A1 from the transistors T_{Dr} and T_{ws} in the pixel 11R to the organic EL device 12 in the pixel 11B is larger than a distance B1 from the retentive capacity C_s in the pixel 11R to the organic EL device 12 in the pixel 11B. Further, a distance A2 from the transistors T_{ws} and T_{Dr} in the pixel 11G

to the organic EL device **12** in the pixel **11B** is larger than a distance **B2** from the retentive capacity C_s in the pixel **11G** to the organic EL device **12** in the pixel **11B**. Thereby, compared to a case that the distance **A1** is smaller than the distance **B1** and further the distance **A2** is smaller than the distance **B2**, entrance amount of the light **L** leaked from the organic layer **35C** in the pixel **11B** into the transistors T_{Dr} and T_{ws} in the pixels **11R** and **11G** adjacent to each other is small. In the result, even if the channels **51** and **55** contain amorphous silicon (a-Si) or microcrystalline Si (μ -Si), lowering of long-term reliability of the transistor is able to be decreased.

[0082] In the case where deterioration of the transistors T_{Dr} and T_{ws} is predictable, even if characteristics of the transistors T_{Dr} and T_{ws} are changed, a voltage applied to the organic EL device **12** is able to be set (corrected) to a desired value. However, in the case where blue light with a short wavelength enters the channel of the transistors T_{Dr} and T_{ws} and thereby the characteristics of the transistors T_{Dr} and T_{ws} are changed, such change is hardly predicted accurately. For example, as illustrated in FIG. **8**, if blue light is irradiated, **S** value is gradually decreased in V_{ds} - I_{ds} characteristics of the transistors T_{Dr} and T_{ws} . However, change of the **S** value is hardly made. Thus, it is not easy to set (correct) a voltage applied to the organic EL device **12** to a desired value while considering deterioration due to blue light.

[0083] However, in this embodiment, as described above, the entrance amount of the light **L** leaked from the organic layer **35C** in the pixel **11B** into the transistors T_{Dr} and T_{ws} in the pixels **11R** and **11G** adjacent to each other is small. Thus, it is almost not necessary to make a correction while considering deterioration due to blue light. Thus, high display quality is able to be retained for a long time.

Modified Examples

[0084] In the foregoing embodiment, the case that the pixels **11R**, **11G**, and **11B** emitting three color light are provided in one pixel **11** has been exemplified. However, it is possible to further provide a pixel emitting other color light. Further, it is possible to provide a pixel other than the pixels **11R** and **11G** in one pixel **11**. In the foregoing both cases, in other pixel adjacent to the pixel **11B**, the transistors T_{Dr} and T_{ws} are preferably arranged far from the pixel **11B** as much as possible.

Module and Application Examples

[0085] A description will be given of application examples of the display unit described in the foregoing embodiment and the modified examples thereof. The display unit of the foregoing embodiment and the like is able to be applied to a display unit of electronic devices in any field for displaying a video signal inputted from outside or a video signal generated inside as an image or a video such as a television device, a digital camera, a notebook personal computer, a portable terminal device such as a mobile phone, and a video camera.

Module

[0086] The display unit of the foregoing embodiment and the like is incorporated in various electronic devices such as after-mentioned first to fifth application examples as a module as illustrated in FIG. **9**, for example. In the module, for example, a region **210** exposed from a member (not

illustrated) sealing the display section **10** is provided in a side of a substrate **2**, and an external connection terminal (not illustrated) is formed in the exposed region **210** by extending wirings of the timing control circuit **21**, the horizontal drive circuit **22**, the writing scanning circuit **23**, and the power source scanning circuit **24**. The external connection terminal may be provided with a Flexible Printed Circuit (FPC) **220** for inputting and outputting a signal.

First Application Example

[0087] FIG. **10** illustrates an appearance of a television device to which the display unit of the foregoing embodiment and the like is applied. The television device has, for example, a video display screen section **300** including a front panel **310** and a filter glass **320**. The video display screen section **300** is composed of the display unit of the foregoing embodiment and the like.

Second Application Example

[0088] FIGS. **11A** and **11B** illustrate an appearance of a digital camera to which the display unit of the foregoing embodiment and the like is applied. The digital camera has, for example, a light emitting section for a flash **410**, a display section **420**, a menu switch **430**, and a shutter button **440**. The display section **420** is composed of the display unit according to the foregoing embodiment and the like.

Third Application Example

[0089] FIG. **12** illustrates an appearance of a notebook personal computer to which the display unit of the foregoing embodiment and the like is applied. The notebook personal computer has, for example, a main body **510**, a keyboard **520** for operation of inputting characters and the like, and a display section **530** for displaying an image. The display section **530** is composed of the display unit according to the foregoing embodiment and the like.

Fourth Application Example

[0090] FIG. **13** illustrates an appearance of a video camera to which the display unit of the foregoing embodiment and the like is applied. The video camera has, for example, a main body **610**, a lens for capturing an object **620** provided on the front side face of the main body **610**, a start/stop switch in capturing **630**, and a display section **640**. The display section **640** is composed of the display unit according to the foregoing embodiment and the like.

Fifth Application Example

[0091] FIGS. **14A** to **14G** illustrate an appearance of a mobile phone to which the display unit of the foregoing embodiment and the like is applied. In the mobile phone, for example, an upper package **710** and a lower package **720** are jointed by a joint section (hinge section) **730**. The mobile phone has a display **740**, a sub-display **750**, a picture light **760**, and a camera **770**. The display **740** or the sub-display **750** is composed of the display unit according to the foregoing embodiment and the like.

[0092] While the invention has been described with reference to the embodiment, the modified examples thereof, and the application examples, the invention is not limited to the foregoing embodiment and the like, and various modifications may be made.

[0093] For example, in the foregoing embodiment and the like, the description has been given of the case that the display unit is an active matrix type. However, the structure of the pixel circuit 13 for driving the active matrix is not limited to the case described in the foregoing embodiment and the like, and a capacity device or a transistor may be added to the pixel circuit 13 according to needs. In this case, according to the change of the pixel circuit 13, a necessary drive circuit may be added in addition to the horizontal drive circuit 22, the writing scanning circuit 23, and the power source scanning circuit 24 described above.

[0094] Further, in the foregoing embodiment and the like, driving of the horizontal drive circuit 22, the writing scanning circuit 23, and the power source scanning circuit 24 is controlled by the signal retention control circuit 21B. However, other circuit may control driving of the horizontal drive circuit 22, the writing scanning circuit 23, and the power source scanning circuit 24. Further, the horizontal drive circuit 22, the writing scanning circuit 23, and the power source scanning circuit 24 may be controlled by a hardware (circuit) or may be controlled by software (program).

[0095] Further, in the foregoing embodiment and the like, the description has been given of the case that the source and the drain of the transistor T_{ws} and the source and the drain of the transistor T_{Dr} are fixed. However, it is needless to say that according to the flowing direction of current, opposing relation between the source and the drain may be opposite to that of the foregoing explanation.

[0096] Further, in the foregoing embodiment and the like, the description has been given of the case that the transistors T_{ws} and T_{Dr} are formed from the n channel MOS type TFT. However, it is possible that at least one of the transistors T_{ws} and T_{Dr} is formed from a p channel MOS type TFT. In the case where the transistor T_{Dr} is formed from the p channel MOS type TFT, the anode 35A of the organic EL device 12 becomes a cathode and the cathode 35B of the organic EL device 12 becomes an anode in the foregoing embodiment and the like. Further, in the foregoing embodiment and the like, the transistors T_{ws} and T_{Dr} are not necessarily the amorphous silicon type TFT or the micro silicon type TFT, but may be, for example, a low temperature polysilicon type TFT.

[0097] The present application contains subject matter related to that disclosed in Japanese Priority Patent Application JP 2009-061713 filed in the Japan Patent Office on Mar. 13, 2009, the entire contents of which is hereby incorporated by reference.

[0098] It should be understood by those skilled in the art that various modifications, combinations, sub-combinations and alternations may occur depending on design requirements and other factors insofar as they are within the scope of the appended claims or the equivalents thereof.

What is claimed is:

1. A display unit comprising a display section having a plurality of organic EL devices with light emitting color different from each other and a plurality of pixel circuits that are singly provided for every said organic EL device for every pixel, wherein

the pixel circuit has a first transistor for writing a video signal, a second transistor for driving the organic EL device based on the video signal written by the first transistor, and a retentive capacity, and

out of the first transistor and the second transistor, a third transistor provided correspondingly to a second organic EL device adjacent to a first organic EL device is arranged farther from the first organic EL device than a first retentive capacity provided correspondingly to the second organic EL device out of the retentive capacity.

2. The display unit according to claim 1, wherein the third transistor is arranged on the side opposite to the first organic EL device with respect to the first retentive capacity.

3. The display unit according to claim 1, wherein the first organic EL device has an organic layer generating light that may deteriorate the first transistor and the second transistor.

4. The display unit according to claim 3, wherein the organic layer contains a material emitting blue light.

5. The display unit according to claim 3, wherein the third transistor has a channel containing amorphous silicon (a-Si) or microcrystalline Si (μ -Si).

* * * * *

专利名称(译)	显示单元		
公开(公告)号	US20190157365A1	公开(公告)日	2019-05-23
申请号	US16/170726	申请日	2018-10-25
[标]申请(专利权)人(译)	索尼公司		
申请(专利权)人(译)	索尼公司		
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IPC分类号	H01L27/32 G09G3/3233		
CPC分类号	H01L27/3262 H01L27/3206 H01L27/3265 H01L27/3244 G09G3/3233 H01L27/3211 G09G2300/0452 H01L27/3276 G09G2300/0809 H01L27/3218 Y10S428/917		
优先权	2009061713 2009-03-13 JP		
其他公开文献	US10672850		
外部链接	Espacenet USPTO		

摘要(译)

提供一种降低晶体管的长期可靠性的显示单元。显示单元包括：显示部分，具有多个彼此不同的发光颜色的有机EL器件；以及为每个像素单独地为每个所述有机EL器件提供的多个像素电路。像素电路具有用于写入视频信号的第一晶体管，用于基于由第一晶体管写入的视频信号驱动有机EL器件的第二晶体管，以及保持电容，以及第一晶体管和第二晶体管，对应于与第一有机EL器件相邻的第二有机EL器件设置的第三晶体管布置得比第一有机EL器件更远离第一保持电容，第一保持电容对应于第二有机EL器件而不是保持电容。

